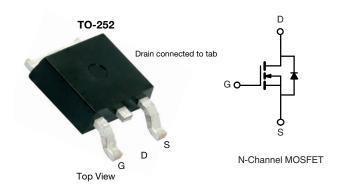


Vishay Siliconix

# Automotive N-Channel 300 V (D-S) 175 °C MOSFET

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	300			
$R_{DS(on)}(\Omega)$ at $V_{GS} = 10 \text{ V}$	0.330			
I <sub>D</sub> (A)	10			
Configuration	Single			



#### **FEATURES**

- TrenchFET® power MOSFET
- Package with low thermal resistance
- AEC-Q101 qualified d
- 100 % R<sub>a</sub> tested
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



ORDERING INFORMATION	
Package	TO-252
Lead (Pb)-free and Halogen-free	SQD10N30-330H-GE3

ABSOLUTE MAXIMUM RATINGS (T <sub>C</sub> = 25 °C, unless otherwise noted)					
PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-Source Voltage	$V_{DS}$	300	V		
Gate-Source Voltage	$V_{GS}$	± 30			
Continuous Drain Current	T <sub>C</sub> = 25 °C	l <sub>D</sub>	10		
Continuous Diain Current	T <sub>C</sub> = 125 °C		5		
Continuous Source Current (Diode Conduction) a	$I_S$	50	Α		
Pulsed Drain Current <sup>b</sup>	I <sub>DM</sub>	16			
Single Pulse Avalanche Current <sup>e</sup>	L = 0.05 mH	I <sub>AS</sub>	12.65		
Single Pulse Avalanche Energy e	L = 0.03 IIII	E <sub>AS</sub>	4	mJ	
Maximum Power Dissipation <sup>b</sup>	T <sub>C</sub> = 25 °C		107	W	
iviaximum Fower Dissipation 5	T <sub>C</sub> = 125 °C		35	VV	
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	°C		

THERMAL RESISTANCE RATINGS				
PARAMETER		SYMBOL	LIMIT	UNIT
Junction-to-Ambient F	PCB Mount c	$R_{thJA}$	50	°C/W
Junction-to-Case (Drain)		R <sub>thJC</sub>	1.4	C/VV

#### Notes

- a. Package limited.
- b. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.
- c. When mounted on 1" square PCB (FR4 material).
- d. Parametric verification ongoing.

S15-1136-Rev. C, 12-May-15

e.  $1.5 \text{ k}\Omega$  resistance in series with the gate.

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$V_{GS} = 0 \text{ V} \qquad V_{DS} = 0 \text{ V}$ On-State Drain Current \$a\$ $I_{D(on)} \qquad V_{GS} = 10 \text{ V}$ $V_{GS} = 10 \text{ V}$ $V_{DS} = 15 \text{ V}$ $V_{DS} = 10 \text{ V}$ $V_{DS$	$_{D}$ = 250 μA $_{GS}$ = ± 30 V $_{DS}$ = 300 V = 300 V, $_{J}$ = 125 °C = 300 V, $_{J}$ = 175 °C $_{DS}$ ≥ 5 V $_{D}$ = 14 A = 14 A, $_{J}$ = 125 °C = 14 A, $_{J}$ = 175 °C	300 3.4 - - - - 10 - -	- 3.8 - - - - - - 0.275 -	- 4.4 ± 100 1 50 250 - 0.330 0.733	V nA μA
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	$_{D}$ = 250 μA $_{GS}$ = ± 30 V $_{DS}$ = 300 V = 300 V, $_{J}$ = 125 °C = 300 V, $_{J}$ = 175 °C $_{DS}$ ≥ 5 V $_{D}$ = 14 A = 14 A, $_{J}$ = 125 °C = 14 A, $_{J}$ = 175 °C	3.4 - - - 10 - -	- - - - - 0.275	± 100  1  50  250  -  0.330  0.733	nA μA
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	$V_{DS} = 300 \text{ V}$ $V_{DS} $	- - - 10 - -	- - - - - 0.275	± 100  1  50  250  -  0.330  0.733	nA μA
	$V_{DS} = 300 \text{ V}$ = 300 V, $T_J = 125 \text{ °C}$ = 300 V, $T_J = 175 \text{ °C}$ $V_{DS} \ge 5 \text{ V}$ $I_D = 14 \text{ A}$ = 14 A, $T_J = 125 \text{ °C}$ = 14 A, $T_J = 175 \text{ °C}$	- - - 10 - -	- - - - 0.275	1 50 250 - 0.330 0.733	μA
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	= 300 V, $T_J = 125 ^{\circ}\text{C}$ = 300 V, $T_J = 175 ^{\circ}\text{C}$ $V_{DS} \ge 5 ^{\circ}\text{V}$ $I_D = 14 ^{\circ}\text{A}$ = 14 A, $T_J = 125 ^{\circ}\text{C}$ = 14 A, $T_J = 175 ^{\circ}\text{C}$	- 10 - -	- 0.275 -	50 250 - 0.330 0.733	A
$V_{GS} = 0 \ V  V_{DS} = 0 \ V_{DS} = $	= 300 V, $T_J = 175$ °C $V_{DS} \ge 5$ V $I_D = 14$ A = 14 A, $T_J = 125$ °C = 14 A, $T_J = 175$ °C	-	- 0.275 -	250 - 0.330 0.733	A
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	$V_{DS} \ge 5 \text{ V}$ $I_D = 14 \text{ A}$ $14 \text{ A}, T_J = 125 ^{\circ}\text{C}$ $14 \text{ A}, T_J = 175 ^{\circ}\text{C}$	-	- 0.275 -	- 0.330 0.733	
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	I <sub>D</sub> = 14 A 14 A, T <sub>J</sub> = 125 °C 14 A, T <sub>J</sub> = 175 °C	-	0.275	0.330	
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	: 14 A, T <sub>J</sub> = 125 °C : 14 A, T <sub>J</sub> = 175 °C	-	-	0.733	
Forward Transconductance $^{\rm b}$ $g_{\rm fs}$ $V_{\rm DS} = 10~{\rm V}$ $I_{\rm D} = 15~{\rm V}$ , $I_{\rm DS} = 10~{\rm V}$	14 A, T <sub>J</sub> = 175 °C	-			0
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$			-	1 000	Ω
$\begin{tabular}{c cccc} \hline \textbf{Dynamic}^b \\ \hline Input Capacitance & $C_{iss}$ \\ \hline Output Capacitance & $C_{oss}$ & $V_{GS}=0 \ V$ & $V_{DS}$ \\ \hline Reverse Transfer Capacitance & $C_{rss}$ & \\ \hline Total Gate Charge $^c$ & $Q_g$ & \\ \hline Gate-Source Charge $^c$ & $Q_{gs}$ & $V_{GS}=10 \ V$ & $V_{DS}$ \\ \hline \end{tabular}$	I <sub>D</sub> = 14 A	-		1.000	
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$			26	-	S
Output Capacitance $C_{oss}$ $V_{GS} = 0 \text{ V}$ $V_{DS}$ Reverse Transfer Capacitance $C_{rss}$ Total Gate Charge $^{\circ}$ $Q_{g}$ Gate-Source Charge $^{\circ}$ $Q_{gs}$ $V_{GS} = 10 \text{ V}$ $V_{DS}$					
Reverse Transfer Capacitance $C_{rss}$ Total Gate Charge $^{\circ}$ $Q_{g}$ Gate-Source Charge $^{\circ}$ $Q_{gs}$ $V_{GS} = 10 \text{ V}$ $V_{DS} = 10 \text{ V}$		-	1749	2190	
Total Gate Charge $^{\circ}$	V <sub>DS</sub> = 25 V, f = 1 MHz		112	140	pF
Gate-Source Charge $^{c}$ $Q_{gs}$ $V_{GS} = 10 \text{ V}$ $V_{DS}$			44	55	
		-	31	47	
Gate-Drain Charge <sup>c</sup> Q <sub>gd</sub>	$V_{GS} = 10 \text{ V}$ $V_{DS} = 150 \text{ V}, I_D = 7 \text{ A}$		8	-	nC
		-	9.6	-	
Gate Resistance R <sub>g</sub> f = 1 I	f = 1 MHz		0.8	3	Ω
Turn-On Delay Time <sup>c</sup> t <sub>d(on)</sub>	$V_{DD}$ = 150 V, $R_L$ = 21 $\Omega$ $I_D \cong 7$ A, $V_{GEN}$ = 10 V, $R_g$ = 1 $\Omega$		10	15	
Rise Time $^{c}$ $t_{r}$ $V_{DD} = 150 \text{ V}$			18	28	ns
Turn-Off Delay Time $^{c}$ $t_{d(off)}$ $I_{D} \cong 7 \text{ A, V}_{GEN} =$			20	30	
Fall Time <sup>c</sup> t <sub>f</sub>			8	12	
Source-Drain Diode Ratings and Characteristics b					
Pulsed Current <sup>a</sup> I <sub>SM</sub>			-	16	Α
Forward Voltage $V_{SD}$ $I_F = 25 \text{ A}, \text{ V}_{SD}$	I <sub>F</sub> = 25 A, V <sub>GS</sub> = 0 V		0.9	1.5	V

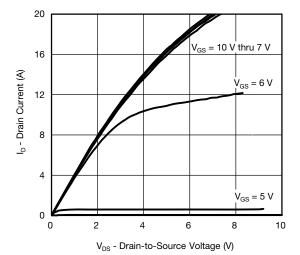
#### Notes

- a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

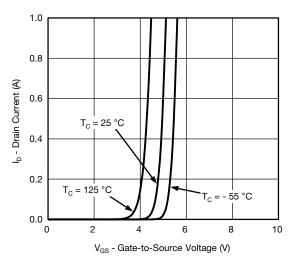
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



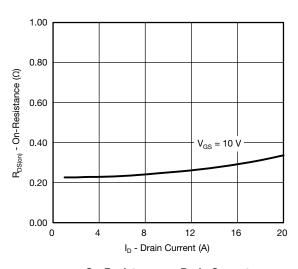
### **TYPICAL CHARACTERISTICS** (T<sub>A</sub> = 25 °C, unless otherwise noted)



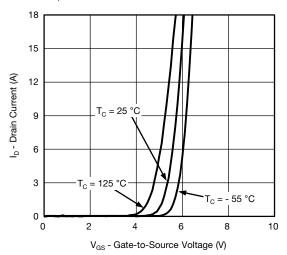
#### **Output Characteristics**



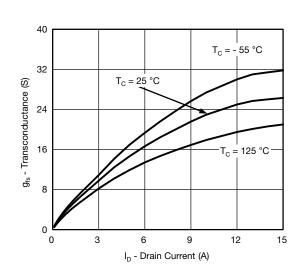
### Transfer Characteristics



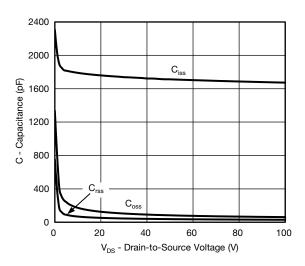
On-Resistance vs. Drain Current



#### **Transfer Characteristics**



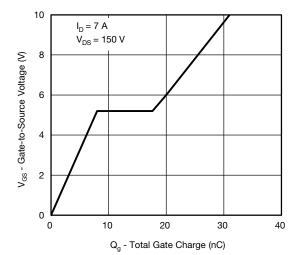
#### Transconductance



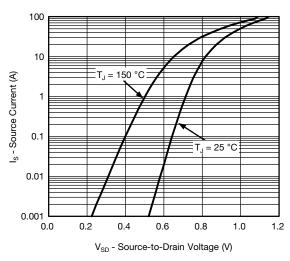
Capacitance



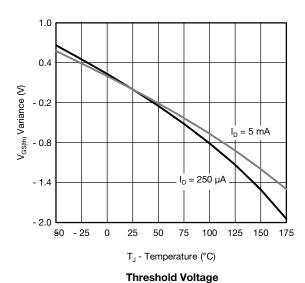
### **TYPICAL CHARACTERISTICS** (T<sub>A</sub> = 25 °C, unless otherwise noted)

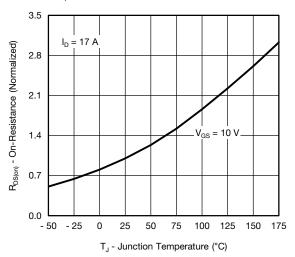


#### **Gate Charge**

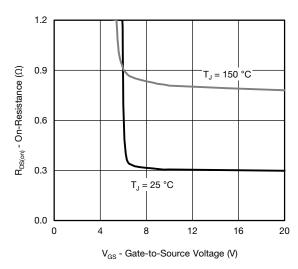


## Source Drain Diode Forward Voltage

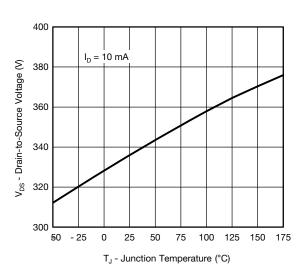




#### On-Resistance vs. Junction Temperature



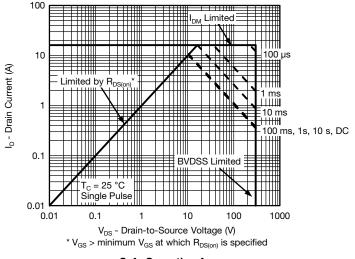
#### On-Resistance vs. Gate-to-Source Voltage



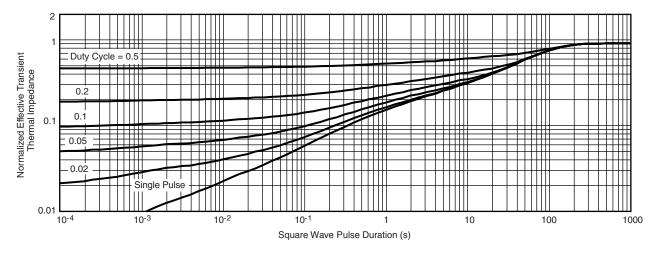
Drain Source Breakdown vs. Junction Temperature



## **THERMAL RATINGS** ( $T_A = 25$ °C, unless otherwise noted)



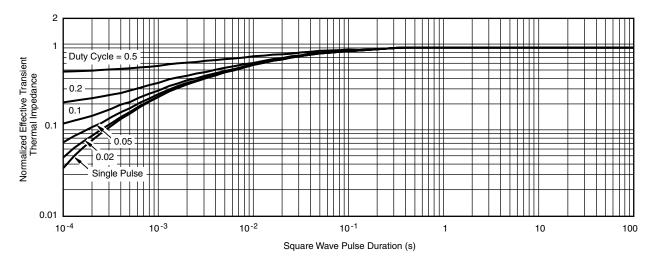
#### Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Ambient



## THERMAL RATINGS (T<sub>A</sub> = 25 °C, unless otherwise noted)



#### Normalized Thermal Transient Impedance, Junction-to-Case

#### Note

- The characteristics shown in the two graphs
  - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
  - Normalized Transient Thermal Impedance Junction-to-Case (25 °C) are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?67070.



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REVISION HISTORY <sup>a</sup>					
REVISION	DATE	DESCRIPTION OF CHANGE			
В	26-Feb-2015	UIS changed			
С	04-May-2015	• R <sub>g</sub> , C <sub>iss</sub> and t <sub>r</sub> updated			

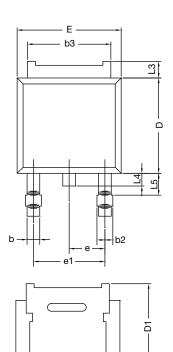
#### Note

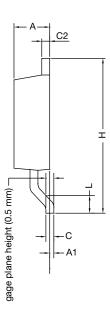
a. As of April 2014



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## **TO-252AA Case Outline**





	MILLIN	METERS	INC	HES	
DIM.	MIN.	MAX.	MIN.	MAX.	
Α	2.18	2.38	0.086	0.094	
A1	-	0.127	-	0.005	
b	0.64	0.88	0.025	0.035	
b2	0.76	1.14	0.030	0.045	
b3	4.95	5.46	0.195	0.215	
С	0.46	0.61	0.018	0.024	
C2	0.46	0.89	0.018	0.035	
D	5.97	6.22	0.235	0.245	
D1	4.10	-	0.161	-	
Е	6.35	6.73	0.250	0.265	
E1	4.32	-	0.170	-	
Н	9.40	10.41	0.370	0.410	
е	2.28	BSC	0.090	BSC	
e1	4.56 BSC		0.180 BSC		
L	1.40	1.78	0.055	0.070	
L3	0.89	1.27	0.035	0.050	
L4	-	1.02	-	0.040	
L5	1.01	1.52	0.040	0.060	
ECN: T13-0592-Rev. A, 02-Sep-13					

### DWG: 6019

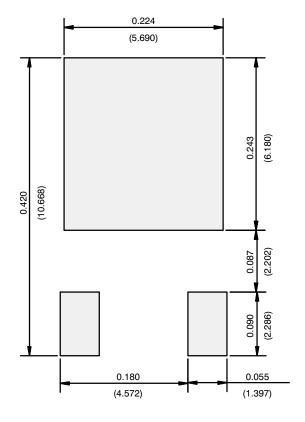
Note

• Dimension L3 is for reference only.

Revision: 02-Sep-13 Document Number: 64424



### **RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)**



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOTE



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